



Part Number : [2147352000](#)

Product Description : zCD (CDFP) Connector Assembly, 16X, 120 Circuits, PCIe Gen 5, 0.75mm Pitch, with EMI Fingers and EMI Gasket, Gold (Au) Over Nickel Plated

Series Number : 214735

Status : Active

Product Category : High-Speed I/O Connectors

Engineering Number : 2147351000



Documents & Resources

Drawings


[2147352000_sd.pdf](#)

Tooling Specifications

[2002142702-000.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)7663-DC (21 Jan 2025)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	High-Speed I/O Connectors
Series	214735
Description	zCD (CDFP) Connector Assembly, 16X, 120 Circuits, PCIe Gen 5, 0.75mm Pitch, with EMI Fingers and EMI Gasket, Gold (Au) Over Nickel Plated
Application	Wire-to-Board
Component Type	Receptacle
Product Name	CDFP,zCD
Type	Pluggable
UPC	196823067693

Agency

UL	E29179
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Electrical

Current - Maximum per Contact	1.0A
Data Rate	28.0 Gbps
Grounding to Panel	Bezel
Shield Type	EMI Fingers, EMI Gasket
Shielded	Yes
Voltage - Maximum	30V AC (RMS)/DC

Physical

Circuits (Loaded)	120
Color - Resin	Black
Durability (mating cycles max)	250

Flammability	94V-0
Gender	Female
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	33.890/g
Number of Rows	4
Orientation	Right Angle
Packaging Type	Tray
Panel Mount	Yes
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Pitch - Mating Interface	0.75mm
Plating min - Mating	0.762µm
Plating min - Termination	0.762µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	1
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Through Hole - Compliant Pin